

Electronic Patent Application Fee Transmittal

Application Number:	10785176			
Filing Date:	23-Feb-2004			
Title of Invention:	Method for fabricating interconnect and interconnect fabricated thereby			
First Named Inventor:	Kun-Hong Chen			
Filer:	Daniel R. McClure			
Attorney Docket Number:	250122-1270			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Independent claims in excess of 3	1201	2	200	400
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				1190